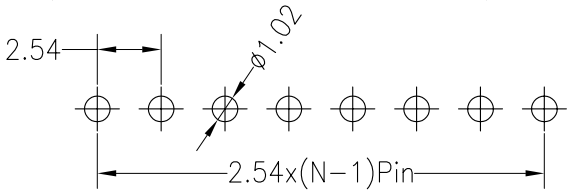
HSF RoHS

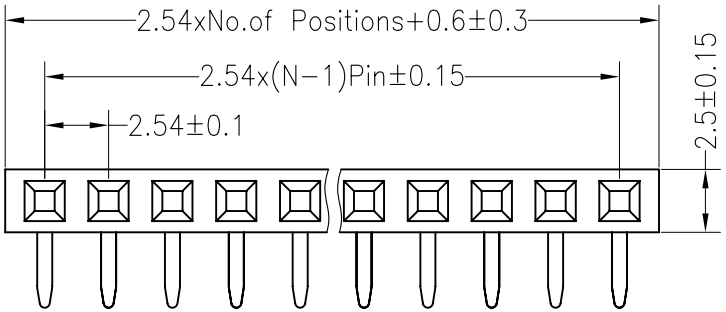
FILE NO :E362810

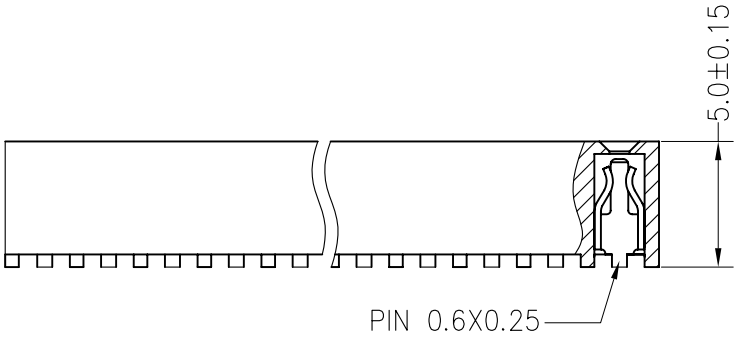
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

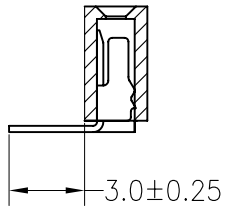
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)









Ordering Information

2250 01 XX X N XX R U X 01

- 01: No.of Pins Per Row 1*40
- XX: Insulator Material Option
  - A=BK−PBT
  - B=BK−PA66
  - C=BK−PA6T
  - D=BK−PA46
  - F=BK−LCP
- X: Contact Plating
  - G0:Gold Flash
  - G2:5U" Gold
  - G3:10U" Gold
  - G4:15U" Gold
  - G5:30U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- XX: Packing
  - 0=PE Bag
  - T=Tube
  - P=Tube+Cap
  - R=Reel+Cap
  - M=Reel+Mylar

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2015.04.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	15.04.28
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	225001XXXNXXRUX01
TITLE:	2.54PF H5.0mm 1xNpin 90° W2.5